CMAD6001

SURFACE MOUNT ULTRA LOW LEAKAGE SILICON SWITCHING DIODE



www.centralsemi.com

DESCRIPTION:

The CENTRAL SEMICONDUCTOR CMAD6001 is an ultra low leakage switching diode ideal for applications where very small size and operational efficiency are prime requirements.

MARKING CODE: Q



APPLICATIONS:

- DC / DC Converters
- Voltage Clamping
- Protection Circuits
- Battery powered applications including Cell Phones, Digital Cameras, Pagers, PDAs, Laptop Computers, etc.

FEATURES:

- Current (I_F=250mA)
- Forward Voltage Drop (V_F=1.1V MAX @ 100mA)
- Low Reverse Current (500pA MAX @ 75V)
- Miniature, 0.8 x 0.6 x 0.4mm, ultra low height profile FEMTOmini™ Surface Mount Package.

MAXIMUM RATINGS: (T _A =25°C)	SYMBOL		UNITS
Continuous Reverse Voltage	v_R	75	V
Peak Repetitive Reverse Voltage	V _{RRM}	100	V
Continuous Forward Current	I _F	250	mA
Peak Forward Surge Current, tp=1.0µs	I _{FSM}	4.0	Α
Peak Forward Surge Current, tp=1.0s	I _{FSM}	1.0	Α
Power Dissipation	P_{D}	100	mW
Operating and Storage Junction Temperature	T _J , T _{stg}	-65 to +150	°C
Thermal Resistance	Θ_{JA}	1250	°C/W

ELECTRICAL CHARACTERISTICS: (T_A=25°C unless otherwise noted)

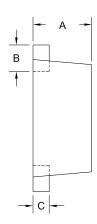
SYMBOL	TEST CONDITIONS	MIN	MAX	UNITS
I_{R}	V _R =75V		500	pA
BV_R	I _R =100μA	100		V
V_{F}	I _F =1.0mA		0.85	V
V_{F}	I _F =10mA		0.95	V
V_{F}	I _F =100mA		1.1	V
c_T	$V_R=0$, f=1.0MHz		2.0	pF
t _{rr}	$I_R = I_F = 10$ mA, $R_L = 100\Omega$ Rec. to 1.0mA		3.0	μs

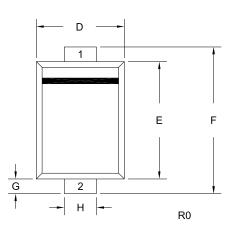
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SOD-923 CASE - MECHANICAL OUTLINE





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DIMENSIONS							
	INCHES		MILLIMETERS				
SYMBOL	MIN	MAX	MIN	MAX			
Α	0.015	0.016	0.39	0.41			
В	0.004	0.010	0.10	0.26			
С	0.003	0.006	0.08	0.14			
D	0.022	0.026	0.55	0.65			
Е	0.030	0.033	0.75	0.85			
F	0.035	0.043	0.90	1.10			
G	0.002	0.006	0.05	0.15			
Н	0.007	0.011	0.17	0.27			

SOD-923 (REV: R0)

OUTSTANDING SUPPORT AND SUPERIOR SERVICES



PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- · Inventory bonding
- · Consolidated shipping options

- · Custom bar coding for shipments
- · Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- · Custom electrical curves
- · Environmental regulation compliance
- · Customer specific screening
- · Up-screening capabilities

- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits
- Custom product and package development

REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

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